

YIELD-0002 (036134-000003)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT: Bradley Dale Mitchell

SERIAL NO.: 09/943,569

FILING DATE: August 30, 2001

TITLE: System and Method for Removing Deposited Material from Within a Semiconductor Fabrication Device

EXAMINER: Alexander Markoff Phone: (703) 308-7545  
Fax: (703) 305-7719

ART UNIT: 1746

#10

**CERTIFICATE OF MAILING**

I hereby certify that this paper is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Mail Stop: Petition, Commissioner for Patents, P. O. Box 1450, Alexandria, VA 22313-1450, on the date printed below:

Date: 4/15/04

Name: Beatrice Orozco  
Beatrice Orozco

**MAIL STOP: PETITION  
COMMISSIONER FOR PATENTS  
P.O. BOX 1450  
ALEXANDRIA, VA 22313-1450**

**TRANSMITTAL FOR FORMAL DRAWINGS**

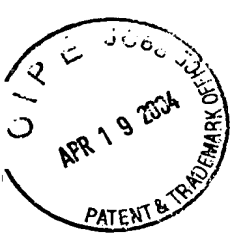
With respect to the above-identified patent application, enclosed herewith for filing are five (5) sheets of Formal Drawings.

Respectfully submitted  
THELEN REID & PRIEST LLP

Dated: April 15, 2004

David B. Ritchie  
David B. Ritchie  
Reg. No. 31,562

Thelen Reid & Priest LLP  
P.O. Box 640640  
San Jose, CA 95164-0640  
Tel.: (408) 292-5800  
Fax: (408) 287-8040



1/5

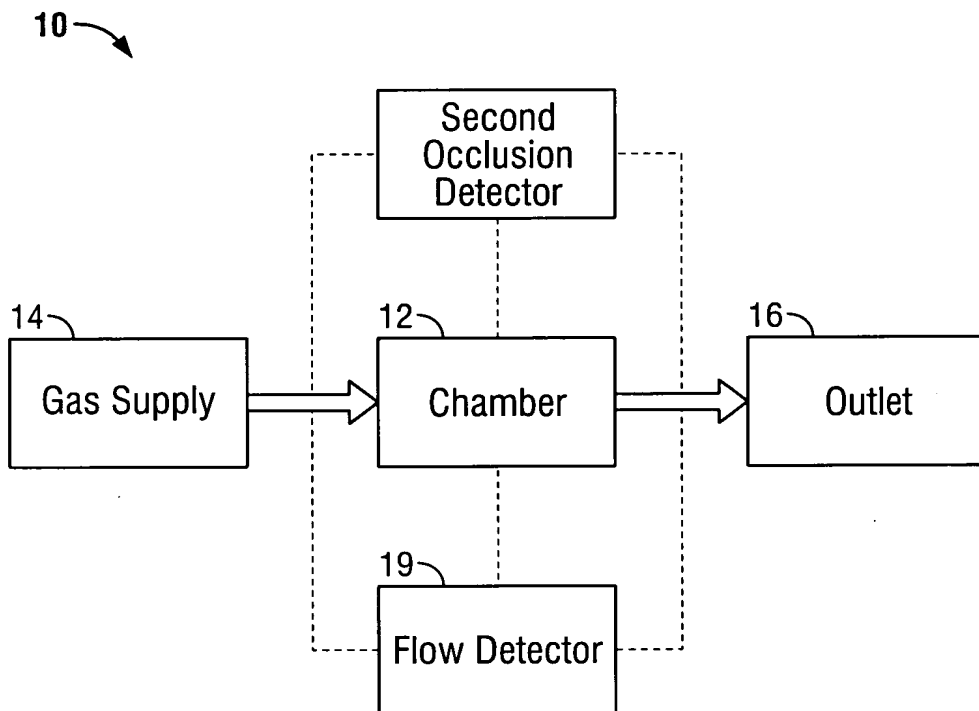
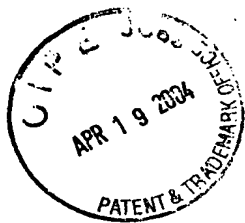


FIG. 1



2/5

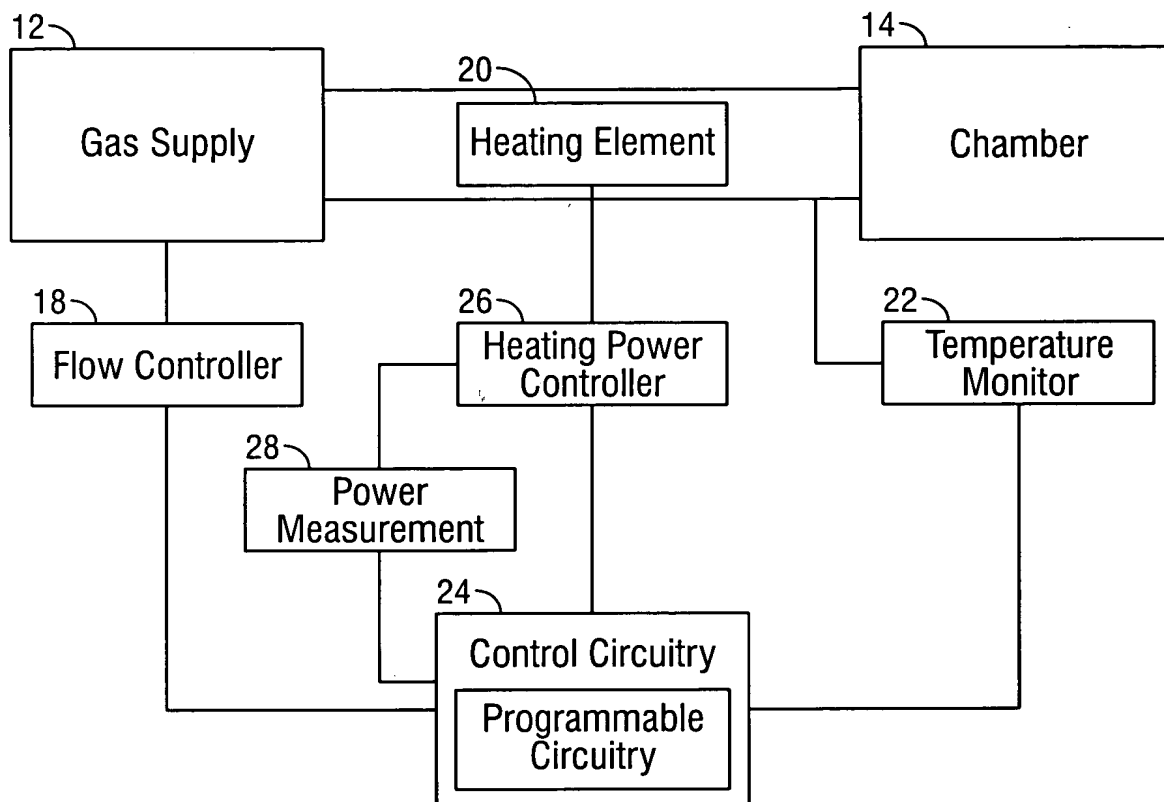


FIG. 2

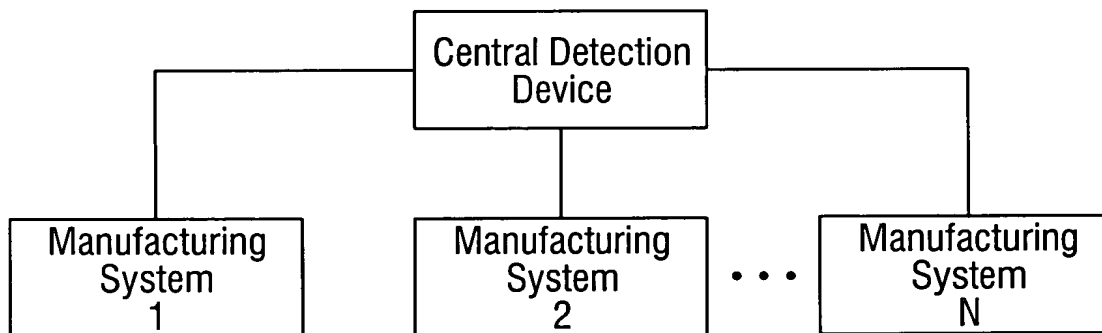
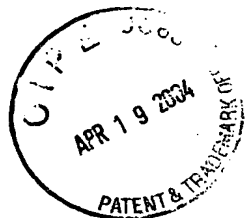


FIG. 3



3/5

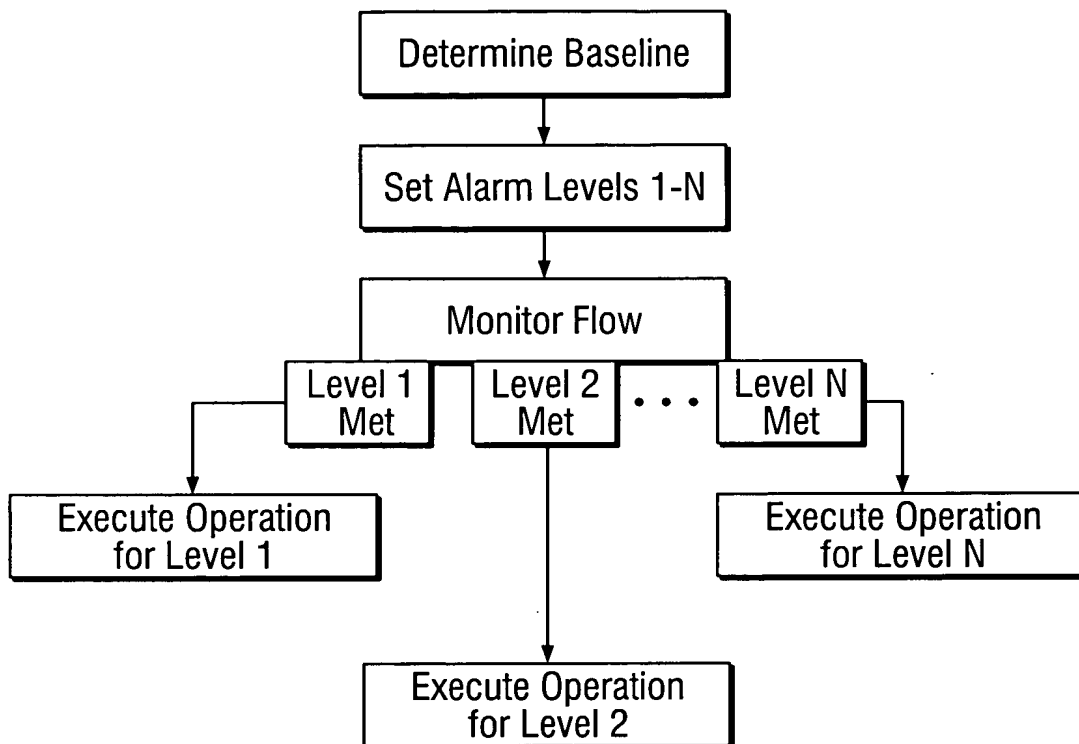


FIG. 4

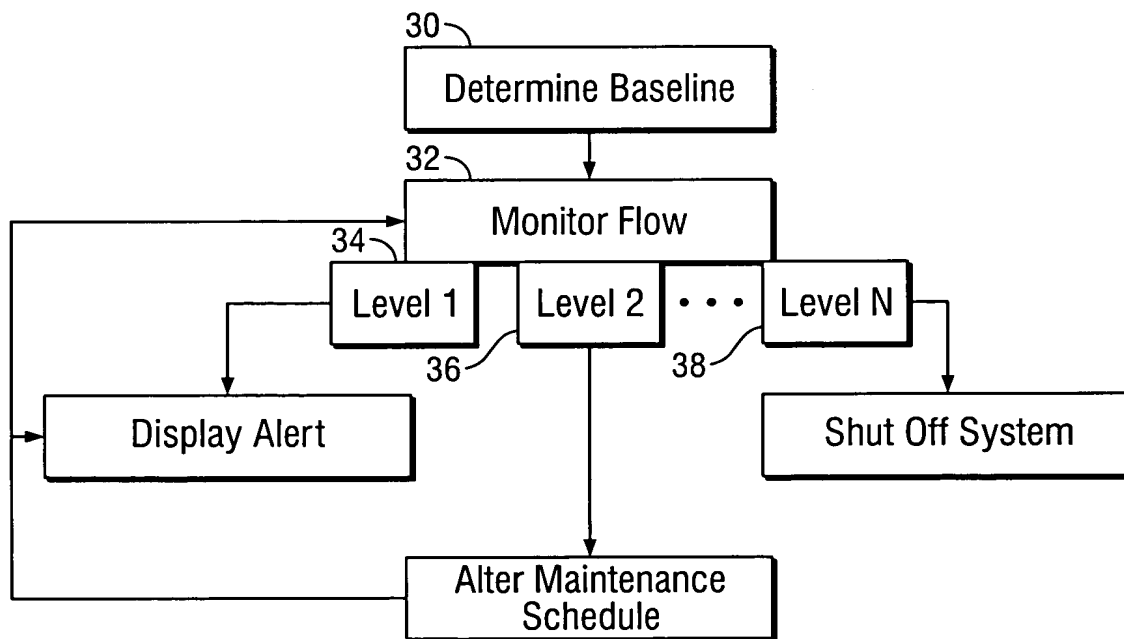
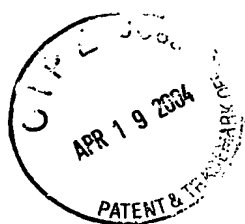


FIG. 5



4/5

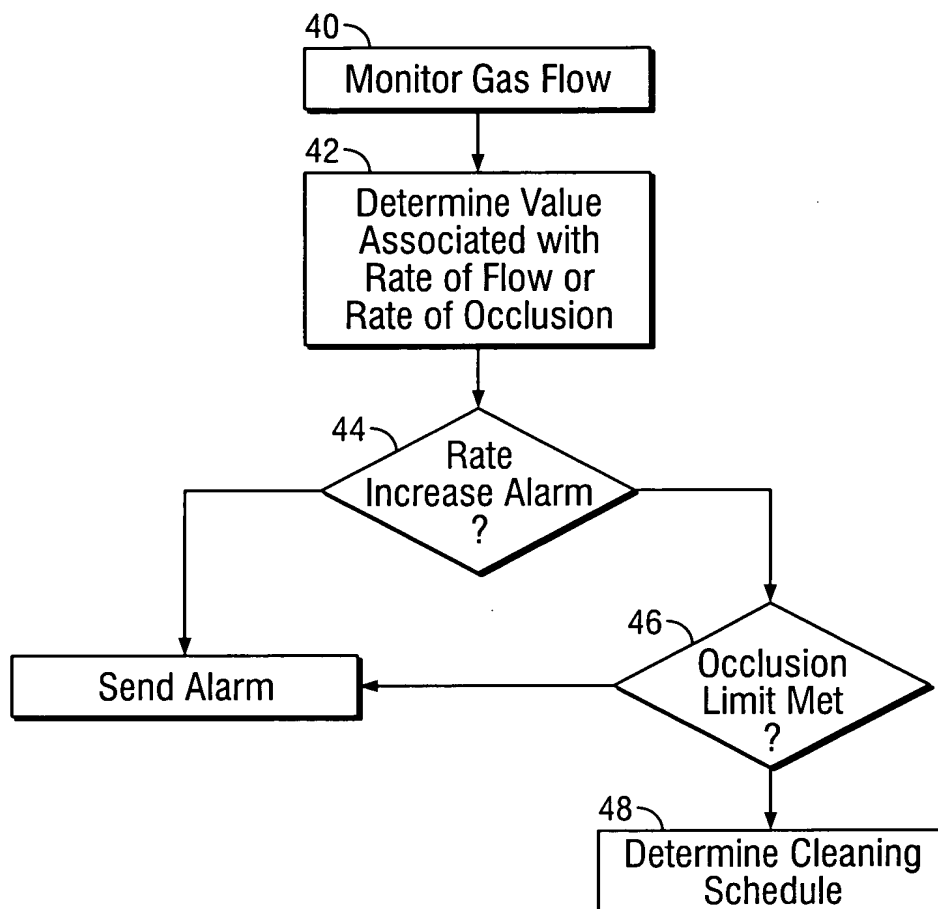


FIG. 6

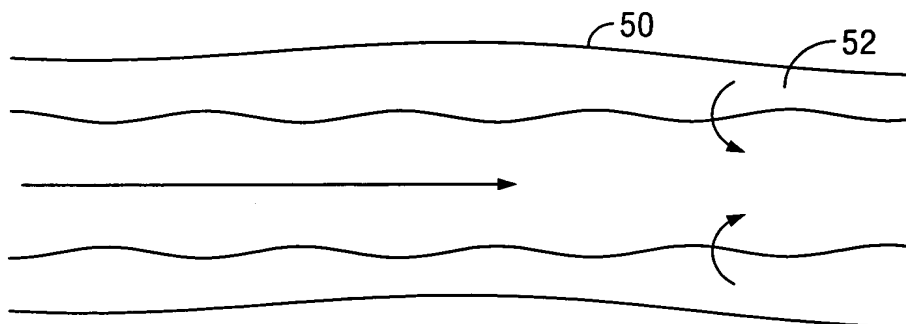
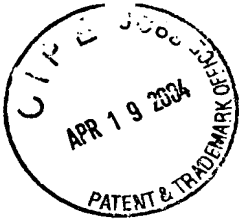


FIG. 7



5/5

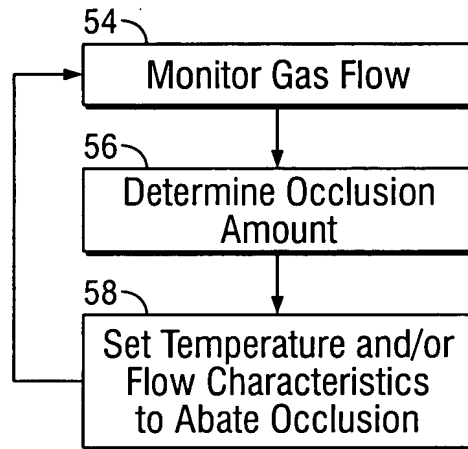


FIG. 8

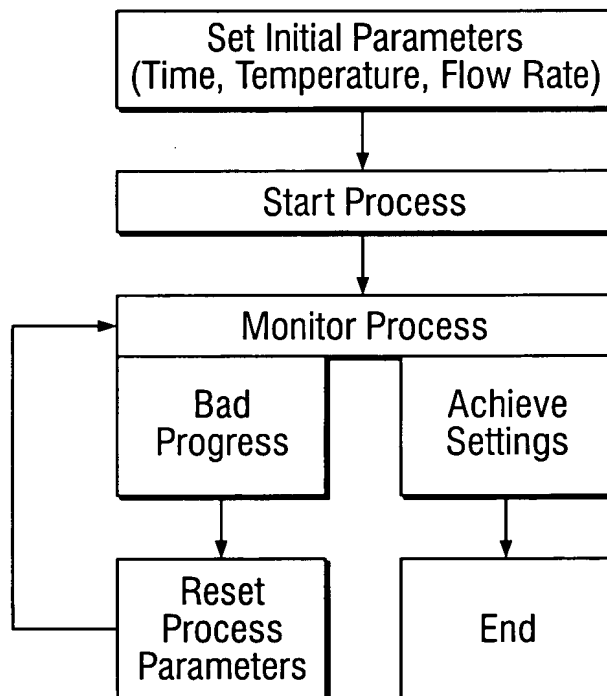


FIG. 9